

April 2014

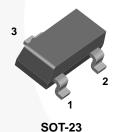
BAV99 200 mA 70 V High Conductance Ultra-Fast Switching **Diode**

Features

- High Conductance: I_F = 200 mA
- Fast Switching Speed: t_{rr} < 6 ns Maximum
- Small Plastic SOT-23 Package
- Series-Pair Configuration

Applications

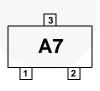
· High-Speed Switching Applications



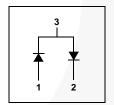
Description

The BAV99 is a 350 mW high-speed switching diode array with series-pair diode configuration. It achieves high-current conductivity, up to 200 mA, in a very small 7mm² footprint. These features make the BAV99 optimal for area-constrained applications that need a little extra power capability.

For common cathode and common anode high-speed switching diodes, explore Fairchild's BAV70 and BAW56. Looking for more options in the SOT-23 package? Check Fairchild's MMBD family.



Connection Diagram



Ordering Information

| Part Number Marking | | Package | Packing Method | |
|---------------------|----|-----------|-----------------------------|--|
| BAV99 | A7 | SOT-23 3L | Tape and Reel, Reel 7 inch | |
| BAV99_D87Z | A7 | SOT-23 3L | Tape and Reel, Reel 13 inch | |

Absolute Maximum Ratings(1)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

| Symbol | Parameter | | Value | Unit |
|--------------------|--|--------------------------------|-------------|------|
| V _{RRM} | Maximum Repetitive Reverse Voltage | | 70 | V |
| I _{F(AV)} | Average Rectified Forward Current | | 200 | mA |
| I _{FSM} | Non-Repetitive Peak Forward Surge Current | Pulse Width = 1.0 Second | 1.0 | A |
| | | Pulse Width = 300 Microseconds | 8.0 | |
| T _{STG} | Storage Temperature Range | | -55 to +150 | °C |
| T _J | Operating Junction Temperature Range | | -55 to +150 | °C |

Note:

These ratings are based on a maximum junction temperature of 150°C.
 These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed

Thermal Characteristics⁽²⁾

or low-duty cycle operations.

Values are at $T_A = 25$ °C unless otherwise noted.

| Symbol | Parameter | Value | Unit |
|-----------------|---|-------|------|
| P_{D} | Power Dissipation | 350 | mW |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 357 | °C/W |

Note:

2. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

Electrical Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

| Symbol | Parameter | Conditions | Min. | Max. | Unit |
|-----------------|----------------------------------|--|------|------|------|
| V_{R} | Breakdown Voltage, per Diode | I _R = 100 μA | 70 | | V |
| V _F | Forward Voltage, per Diode | I _F = 1 mA | | 715 | mV |
| | | I _F = 10 mA | | 855 | |
| | | I _F = 50 mA | | 1.00 | V |
| | | I _F = 150 mA | | 1.25 | |
| I _R | Reverse Leakage, per Diode | V _R = 70 V | | 2.5 | μА |
| | | V _R = 25 V, T _A = 150°C | | 30.0 | |
| | | V _R = 70 V, T _A = 150°C | | 50.0 | |
| C _T | Total Capacitance, per Diode | V _R = 0 V, f = 1.0 MHz | | 1.5 | pF |
| t _{rr} | Reverse-Recovery Time, per Diode | $I_F = I_R = 10 \text{ mA},$ $I_{RR} = 1 \text{ mA},$ $R_L = 100 \Omega$ | | 6.0 | ns |

Typical Performance Characteristics

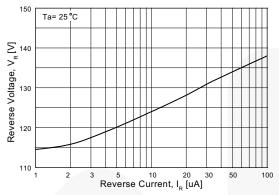


Figure 1. Reverse Voltage vs. Reverse Current

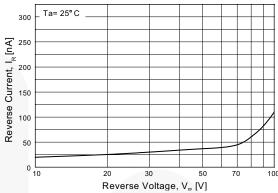


Figure 2. Reverse Current vs. Reverse Voltage

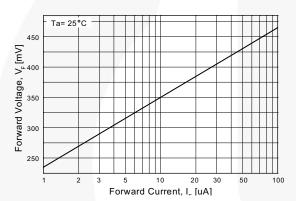


Figure 3. Forward Voltage vs. Forward Current V_F - 1 to 100 μA

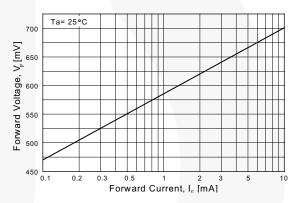


Figure 4. Forward Voltage vs. Forward Current V_F - 0.1 to 10 mA

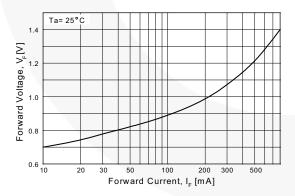


Figure 5. Forward Voltage vs. Forward Current V_{F} - 10 to 800 mA

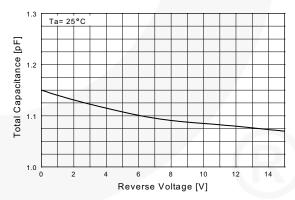


Figure 6. Total Capacitance vs. Reverse Voltage

Typical Performance Characteristics (Continued)

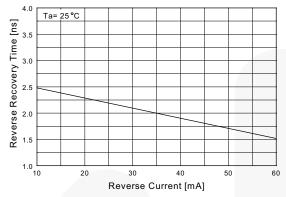


Figure 7. Reverse-Recovery Time vs. Reverse Current

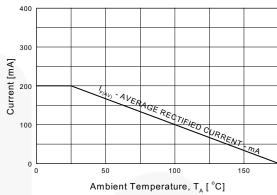


Figure 8. Average Rectified Current ($I_{F(AV)}$) vs. Ambient Temperature (I_A)

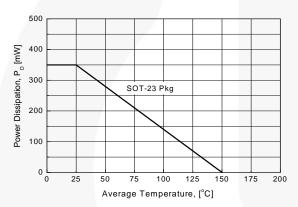


Figure 9. Power Derating Curve

Physical Dimensions

SOT-23

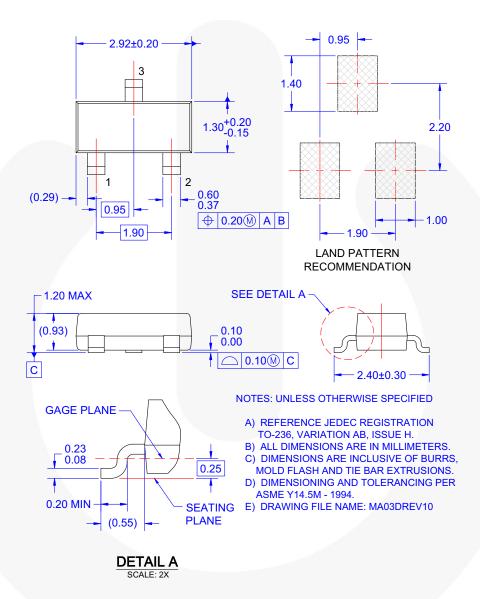


Figure 10. 3-LEAD, SOT23, JEDEC TO-236, LOW PROFILE

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